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Orderable: N/A	Designed for: Public Release	Mod. Date: 5/6/2015
TID #: PMP10654	Project Title: LM5160 Fly-Buck 2-output Module	
Number: PMP10654	Rev: 3	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 1 of 2
Drawn By:	File: PMP10654_sch_rev3.SchDoc	Size: B
Engineer: X Fang	Contact: http://www.ti.com/support	

A

A

ZZ1

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

PCB Number: PMP10654
PCB Rev: B

PCB
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B

B

C

C

D

D

Orderable: N/A	Designed for: Public Release	Mod. Date: 4/17/2015	 TEXAS INSTRUMENTS http://www.ti.com <small>© Texas Instruments 2015</small>
TID #: PMP10654	Project Title: LM5160 Fly-Buck 2-output Module		
Number: PMP10654	Rev: 3	Sheet Title:	
SVN Rev: Version control disabled	Assembly Variant: [No Variations]	Sheet: 2 of 2	
Drawn By:	File: PMP10654_TID_Hardware.SchDoc	Size: B	
Engineer: X Fang	Contact: http://www.ti.com/support		

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